

### **General Description**

The AAT7551 is a dual low threshold P-channel MOSFET designed for the battery, cell phone, and PDA markets. Using AnalogicTech's ultra-high-density MOSFET process and space-saving, small outline, J-lead package, performance superior to that normally found in a TSOP-6 footprint has been squeezed into the footprint of an SC70JW-8 package.

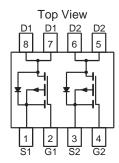
### **Applications**

- Battery Packs
- Battery-Powered Portable Equipment
- Cellular and Cordless Telephones

### **Features**

- Drain-Source Voltage (max): -20V
- Continuous Drain Current¹ (max):
  -2.7A @ 25°C
- Low On-Resistance:
  - 100mΩ @ V<sub>GS</sub> = -4.5V
  - 175mΩ @ V<sub>GS</sub> = -2.5V

### **Dual SC70JW-8 Package**



### **Absolute Maximum Ratings**

 $T_A = 25$ °C, unless otherwise noted.

Symbol	Description	Value	Units		
V <sub>DS</sub>	Drain-Source Voltage		-20	V	
$V_{GS}$	Gate-Source Voltage		±12	v	
	Continuous Drain Current @ T <sub>J</sub> = 150°C¹	$T_A = 25^{\circ}C$	±2.7		
I <sub>D</sub>		T <sub>A</sub> = 70°C	±2.2	Α	
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>		±8	^	
I <sub>S</sub>	Continuous Source Current (Source-Drain Diode) <sup>1</sup>	-0.6			
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	°C		
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C		

### Thermal Characteristics<sup>1</sup>

Symbol	Description		Тур	Max	Units	
$R_{\theta JA}$	Junction-to-Ambient Steady State		132	165	°C/W	
$R_{\theta JA2}$	Junction-to-Ambient t<5 Seconds		83	104		
$R_{\theta JF}$	Junction-to-Foot		60	72		
P <sub>D</sub>	Maximum Power Dissipation	T <sub>A</sub> = 25°C		1.2	W	
		T <sub>A</sub> = 70°C		0.75	VV	

<sup>1.</sup> Based on thermal dissipation from junction to ambient while mounted on a 1" x 1" PCB with optimized layout. A 5-second pulse on a 1" x 1" PCB approximates testing a device mounted on a large multi-layer PCB as in most applications.  $R_{\theta JF} + R_{\theta FA} = R_{\theta JA}$  where the foot thermal reference is defined as the normal solder mounting surface of the device's leads.  $R_{\theta JF}$  is guaranteed by design; however,  $R_{\theta CA}$  is determined by the PCB design. Actual maximum continuous current is limited by the application's design.

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<sup>2.</sup> Pulse test: Pulse Width = 300µs.



### **Electrical Characteristics**

 $T_J = 25$ °C, unless otherwise noted.

Symbol	Description	Conditions	Min	Тур	Max	Units	
DC Chara	cteristics				•		
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_{D} = -250\mu A$	-20			V	
R <sub>DS(ON)</sub>	Drain-Source On-Resistance <sup>1</sup>	$V_{GS} = -4.5V, I_D = -2.7A$		80	100		
		$V_{GS} = -2.5V, I_D = -2.0A$		140	175	- mΩ	
I <sub>D(ON)</sub>	On-State Drain Current <sup>1</sup>	$V_{GS} = -4.5V$ , $V_{DS} = -5V$ (pulsed)	-8			Α	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = -250\mu A$	-0.6			V	
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{GS} = \pm 12V, V_{DS} = 0V$			±100	nA	
	Drain Source Leakage Current	$V_{GS} = 0V, V_{DS} = -20V$			-1		
I <sub>DSS</sub>		$V_{GS} = 0V, V_{DS} = -16V, T_{J} = 70^{\circ}C^{2}$		-5		μA	
g <sub>fs</sub>	Forward Transconductance <sup>1</sup>	$V_{DS} = -5V, I_{D} = -2.7A$		4		S	
Dynamic	Characteristics <sup>2</sup>	•					
$Q_{G}$	Total Gate Charge	$V_{DS} = -10V, R_D = 3.7\Omega, V_{GS} = -4.5V$		5.9			
$Q_{GS}$	Gate-Source Charge	$V_{DS} = -10V, R_D = 3.7\Omega, V_{GS} = -4.5V$		1		nC	
$Q_{GD}$	Gate-Drain Charge	$V_{DS} = -10V, R_D = 3.7\Omega, V_{GS} = -4.5V$		2			
t <sub>D(ON)</sub>	Turn-On Delay	$V_{DS} = -10V, R_D = 3.7\Omega, V_{GS} = -4.5V, R_G = 6\Omega$		22			
t <sub>R</sub>	Turn-On Rise Time	$V_{DS} = -10V, R_D = 3.7\Omega, V_{GS} = -4.5V, R_G = 6\Omega$		10			
t <sub>D(OFF)</sub>	Turn-Off Delay	$V_{DS} = -10V, R_D = 3.7\Omega, V_{GS} = -4.5V, R_G = 6\Omega$		20		ns	
t <sub>F</sub>	Turn-Off Fall Time	$V_{DS} = -10V, R_D = 3.7\Omega, V_{GS} = -4.5V, R_G = 6\Omega$		40			
Source-D	rain Diode Characteristics						
V <sub>SD</sub>	Source-Drain Forward	$V_{GS} = 0$ , $I_{S} = -2.7A$			-1.3	V	
	Voltage <sup>1</sup>						
I <sub>S</sub>	Continuous Diode Current <sup>3</sup>				-0.6	Α	

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<sup>1.</sup> Pulse test: Pulse Width = 300µs.

<sup>2.</sup> Guaranteed by design. Not subject to production testing.

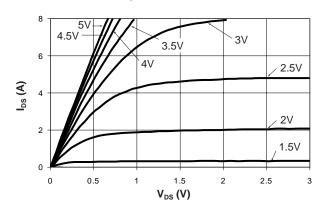
<sup>3.</sup> Based on thermal dissipation from junction to ambient while mounted on a 1" x 1" PCB with optimized layout. A 5-second pulse on a 1" x 1" PCB approximates testing a device mounted on a large multi-layer PCB as in most applications.  $R_{\theta JF} + R_{\theta FA} = R_{\theta JA}$  where the foot thermal reference is defined as the normal solder mounting surface of the device's leads.  $R_{\theta JF}$  is guaranteed by design; however,  $R_{\theta CA}$  is determined by the PCB design. Actual maximum continuous current is limited by the application's design.



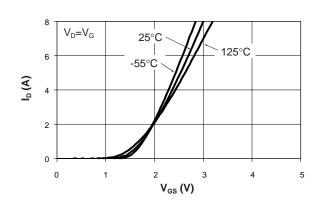
## **Typical Characteristics**

 $T_{.1} = 25^{\circ}$ C, unless otherwise noted.

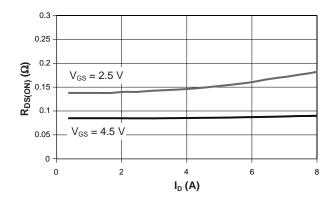
### **Output Characteristics**



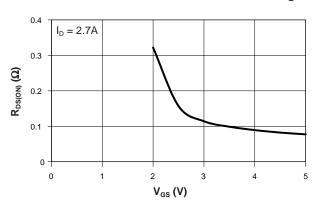
#### **Transfer Characteristics**



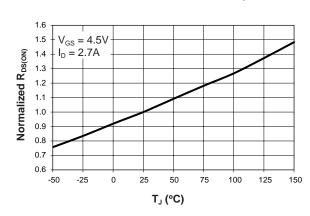
**On-Resistance vs. Drain Current** 



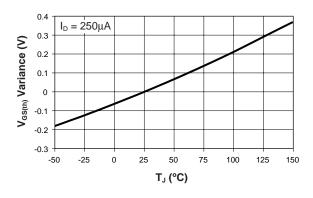
On-Resistance vs. Gate-to-Source Voltage



**On-Resistance vs. Junction Temperature** 



Threshold Voltage



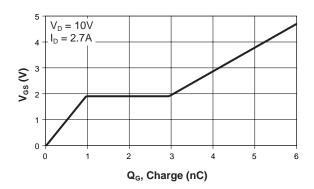
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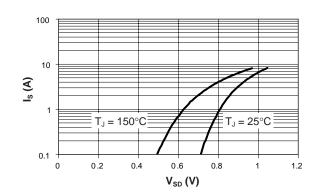
## **Typical Characteristics**

 $T_J = 25^{\circ}$ C, unless otherwise noted.

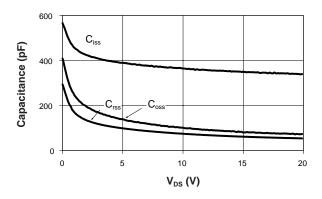
#### **Gate Charge**



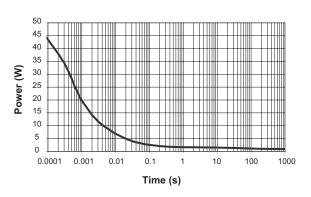
#### Source-Drain Diode Forward Voltage



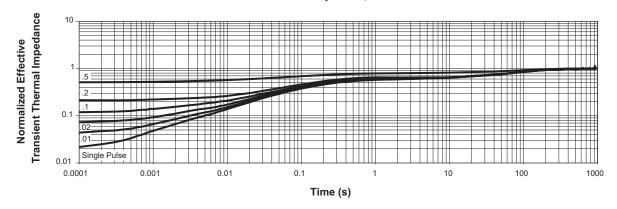
#### Capacitance



#### Single Pulse Power, Junction to Ambient



#### **Transient Thermal Response, Junction to Ambient**



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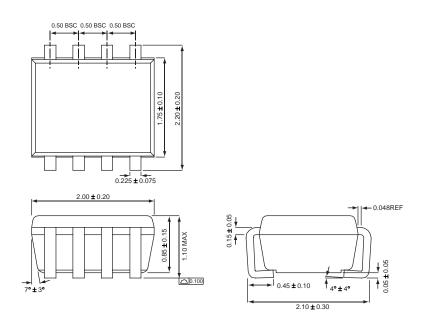


## **Ordering Information**

Package	Marking <sup>1</sup>	Part Number (Tape and Reel) <sup>2</sup>
SC70JW-8	KDXYY	AAT7551IJS-T1

# **Package Information**

#### **SC70JW-8**



All dimensions in millimeters.

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<sup>1.</sup> XYY = assembly and date code.

<sup>2.</sup> Sample stock is generally held on part numbers listed in BOLD.



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